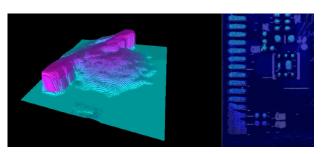


## Solder Paste Inspection



For inspection, a single setup for all measurements, the same tool measures:

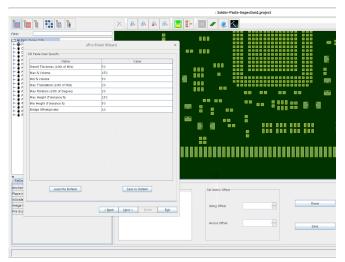
- Height (Presence/Absence)
- Bridging
- Position/Translation
- Paste Height and Volume



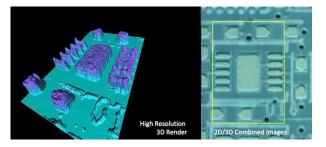
The first part of any SMT process is Paste. MVPs Versa and 900 Series platforms provide high accuracy paste inspection.

High accuracy paste measurements are made using a choice of 10um or 5um 3D measurement systems.

The key aspect of any SPI solution is programming. MVP's solutions allow you to merge stencil and placement data and standard inspection criteria.



Fast Program Set-up



**High Resolution Defect Analysis and Review** 

Our AutoData tools can provide full traceability. Options also allow for Image archiving and full variable data retention. For more information, please contact MVP.